

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Koichi WATANABE et al.

Title:

SPUTTERING TARGET AND PROCESS FOR PRODUCING Si OXIDE

FILM THEREWITH

Appl. No.:

10/573,406

International

9/22/2004

Filing Date:

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3/27/2006

Examiner:

Jason Berman

Art Unit:

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Confirmation

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Number:

REPLY UNDER 37 CFR 1.116

Mail Stop AF **Commissioner for Patents** P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

This communication is responsive to the Final Office Action dated June 22, 2010, concerning the above-referenced patent application.

Applicant has enclosed with this amendment a Petition for Extension of Time to make this response timely.

Remarks begin on page 2 of this document.